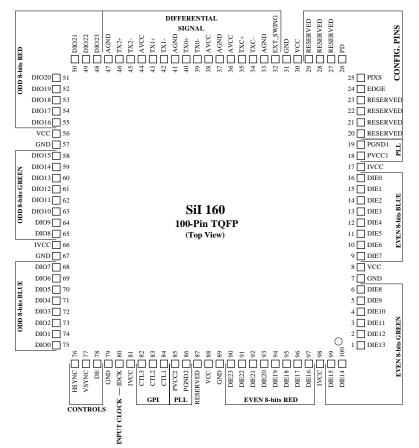
### **General Description**

The SiI 160 transmitter uses PanelLink Digital technology to support displays ranging from VGA to UXGA resolutions (25-165 MHz). The SiI 160 transmitter supports up to true color panels (24 bit/pixel, 16.7M colors) in 1 or 2 pixels/clock mode, and also features an inter-pair skew tolerance up to 1 full input clock cycle. An advanced on-chip jitter filter is also added to extend tolerance to VGA clock jitter. Since all PanelLink products are designed on scaleable CMOS architecture to support future performance requirements while maintaining the same logical interface, system designers can be assured that the interface will be fixed through a number of technology and performance generations.

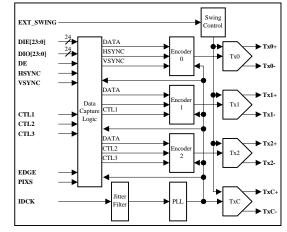
PanelLink Digital technology simplifies PC & display interface design by resolving many of the system level issues associated with high-speed digital design, providing the system designer with a digital interface solution that is quicker to market and lower in cost.

## SiI 160 Pin Diagram



#### Features

- Scaleable Bandwidth: 25-165 MHz (VGA to UXGA)
- Low Power: 3.3V core operation
- High Skew Tolerance: 1 full input clock cycle (6ns at 165 MHz)
- Flexible panel interface: single or dual pixel in at up to 24-bits
- Sync Detect: for Plug & Display "Hot Plugging"
- Cable Distance Support: over 5m with twisted-pair, fiber-optics ready
- Compliant with DVI 1.0 (DVI is backwards compatible with VESA® P&D<sup>TM</sup> and DFP)



## **Functional Block Diagram**



### **Absolute Maximum Conditions**

Note: Permanent device damage may occur if absolute maximum conditions are exceeded.

Functional operation should be restricted to the conditions described under Normal Operating Conditions.									
Symbol	Parameter	Min	Тур	Max	Units				
Vcc	Supply Voltage 3.3V	-0.3		4.0	V				
VI	Input Voltage	-0.3		V <sub>CC</sub> + 0.3	V				
Vo	Output Voltage	-0.3		V <sub>CC</sub> + 0.3	V				
T <sub>A</sub>	Ambient Temperature (with power applied)	-25		105	°C				
T <sub>STG</sub>	Storage Temperature	-40		125	°C				
P <sub>PD</sub>	Package Power Dissipation			1	W				

### **Normal Operating Conditions**

Γ	Symbol	Parameter	Min	Тур	Max	Units
	Vcc	Supply Voltage	3.00	3.3	3.6	V
	V <sub>CCN</sub>	Supply Voltage Noise			100	$mV_{P-P}$
	TA	Ambient Temperature (with power applied)	0	25	70	°C

### **DC Digital I/O Specifications**

Under normal operating conditions unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
VIH	High-level Input Voltage		2			V
VIL	Low-level Input Voltage				0.8	V
Vон	High-level Output Voltage		2.4			V
Vol	Low-level Output Voltage				0.4	V
VCINL	Input Clamp Voltage <sup>1</sup>	$I_{CL} = -18 \text{mA}$			GND -0.8	V
V <sub>CIPL</sub>	Input Clamp Voltage <sup>1</sup>	$I_{CL} = 18 \text{mA}$			IVCC + 0.8	V
VCONL	Output Clamp Voltage <sup>1</sup>	$I_{CL} = -18 \text{mA}$			GND -0.8	V
V <sub>COPL</sub>	Output Clamp Voltage <sup>1</sup>	I <sub>CL</sub> = 18mA			OVCC + 0.8	V
IIL	Input Leakage Current		-10		10	μΑ

Note: <sup>1</sup> Guaranteed by design.

### **DC Specifications**

Under normal operating conditions unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V <sub>OD</sub>	Differential Voltage	$R_{LOAD} = 50 \Omega$				
	Single ended peak to peak amplitude	$R_{EXT SWING} = 510 \Omega$	510	550	590	mV
V <sub>DOH</sub>	Differential High-level Output Voltage <sup>1</sup>			AVCC		V
I <sub>DOS</sub>	Differential Output Short Circuit Current <sup>1</sup>	$V_{OUT} = 0 V$			5	μA
I <sub>PD</sub>	Power-down Current <sup>2</sup>				TBD	mA
I <sub>CCT</sub>	Transmitter Supply Current	DCLK= 165 MHz, 1-pixel/clock mode, (DCLK= 112 MHz, 1-pixel/clock mode) $R_{EXT_SWING} = 680\Omega$ , IVCC = VCC, Typical Pattern <sup>3</sup>		70	95	mA
		DCLK= 165 MHz, 1-pixel/clock mode, (DCLK= 112 MHz, 1-pixel/clock mode) $R_{EXT_SWING} = 680\Omega$ , IVCC = VCC, Worse Case Pattern <sup>4</sup>		90	110	mA

Note:

<sup>1</sup> Guaranteed by design.
<sup>2</sup> Assumes all inputs to the transmitter are not toggling.
<sup>3</sup> The Typical Pattern contains a gray scale area, checkerboard area, and text.
<sup>4</sup> Black and white checkerboard pattern, each checker is one pixel wide.

## **AC Specifications**

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
T <sub>CIP</sub>	IDCK Period, 1 Pixel/Clock		6.06		40	ns	
FCIP	IDCK Frequency, 1 Pixel/Clock		25		165	MHz	
T <sub>CIP</sub>	IDCK Period, 2 Pixels/Clock		12.3		80	ns	
F <sub>CIP</sub>	IDCK Frequency, 2 Pixels/Clock		12.5		81	MHz	
Т <sub>СІН</sub>	IDCK High Time at 165MHz		2			ns	
T <sub>CIL</sub>	IDCK Low Time at 165MHz		2			ns	
T <sub>IJIT</sub>	Worst Case IDCK Clock Jitter <sup>2,3</sup>				2	ns	
T <sub>SIDF</sub>	Data, DE, VSYNC, HSYNC, and CTL[3:1]	EDGE = 0	1.5			ns	
	Setup Time to IDCK falling edge						
THIDF	Data, DE, VSYNC, HSYNC, and CTL[3:1]	EDGE = 0	1.5			ns	
	Hold Time from IDCK falling edge						
T <sub>SIDR</sub>	Data, DE, VSYNC, HSYNC, and CTL[3:1]	EDGE = 1	1.5			ns	
	Setup Time to IDCK rising edge <sup>1</sup>						
T <sub>HIDR</sub>	Data, DE, VSYNC, HSYNC, and CTL[3:1]	EDGE = 1	1.5			ns	
	Hold Time from IDCK rising edge <sup>1</sup>						
T <sub>DDF</sub>	VSYNC, HSYNC, and CTL[3:1] Delay from DE falling edge <sup>1</sup>		T <sub>CIP</sub>			ns	
T <sub>DDR</sub>	VSYNC, HSYNC, and CTL[3:1] Delay to DE rising edge <sup>1</sup>		T <sub>CIP</sub>			ns	
T <sub>HDE</sub>	DE high time <sup>1</sup>				8000T <sub>CIP</sub>	ns	
T <sub>LDE</sub>	DE low time <sup>1</sup>		10T <sub>CIP</sub>			ns	
Slht	Small Swing Low-to-High	$R_{LOAD} = 50\Omega$	170	200	230	ns	
	Transition Time	R <sub>EXT</sub> SWING =					
		510Ω					
Shlt	Small Swing High-to-Low	$R_{LOAD} = 50\Omega$	170	200	230	ns	
	Transition Time	R <sub>EXT SWING</sub> =					
		510Ω					

<sup>1</sup> Guaranteed by design.
<sup>2</sup> Jitter can be estimated by 1) triggering a digital scope at the rising of input clock and 2) measuring the peak to peak time spread of the rising edge of the input clock 1µs after the trigger.
<sup>3</sup> Actual jitter tolerance may be higher depending on the frequency of the jitter.

## **Timing Diagrams**

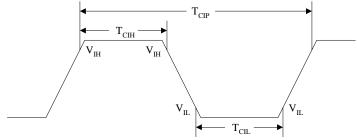


Figure 1. Clock Cycle/High/Low Times

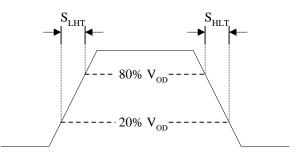


Figure 2. Small Swing Transition Times

## Input Timing

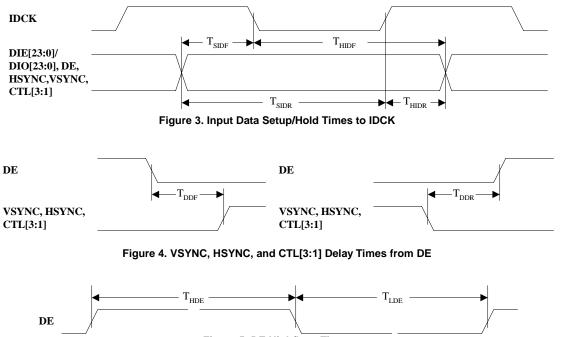


Figure 5. DE High/Low Times

## **Input Pin Description**

Pin Name	Pin #	Туре	Description
DIE23- DIE0	See SiI 160 Pin	In	Even Input Data[23:0] corresponds to 24-bit pixel data for 1-pixel/clock input mode or to the first 24-bit pixel data for 2-pixels/clock mode.
	Diagram		Input data is synchronized to input data clock (IDCK).
			Data can be latched on the rising or the falling edge of IDCK depending on whether EDGE is high or low, respectively.
			Refer to the TFT and DSTN Signal Mapping application notes (SiI/AN-0008-A and SiI/AN-0007-A, respectively) which tabulate the relationship between the input data to the transmitter and output data from the receiver.
DIO23 –	See SiI	In	Input Odd Data[23:0] corresponds to the second 24-bit pixel data for 2-pixels/clock mode.
DIO0	160 Pin Diagram		In 1-pixel/clock mode, these inputs are a don't care. Recommendation is to tie them low for lower power consumption.
			Input data is synchronized to input data clock (IDCK).
			Data can be latched on the rising or the falling edge of IDCK depending on whether EDGE is high or low, respectively.
			Refer to the TFT and DSTN Signal Mapping application notes (SiI/AN-0008-A and SiI/AN-0007-A, respectively) which tabulate the relationship between the input data to the transmitter and output data from the receiver.
IDCK	80	In	Input Data Clock. Input data and control signals can be valid either on the falling or the rising edge of IDCK as selected by the EDGE pin.
DE	78	In	Input Data Enable. This signal qualifies the active data area. DE is <u>always</u> required by the transmitter and <u>must</u> be high during active display time and low during blanking time.
HSYNC	76	In	Horizontal Sync input control signal.
VSYNC	77	In	Vertical Sync input control signal.
CTL1	84	In	General input control signal 1.
CTL2	83	In	General input control signal 2.
CTL3	82	In	General input control signal 3.

# **Configuration Pin Description**

Pin Name	Pin #	Туре	Description
EDGE	24	In	Data/Control Latching Edge. A low level indicates that all input signals (DIE/DIO[23:0], HSYNC, VSYNC, DE, and CTL[3:1]) are latched on the falling edge of IDCK, while a high level (3.3V) indicates that all input signals are latched on the rising edge of IDCK.
PIXS	25	In	Pixel Select. A low level indicates one pixel (up to 24-bits) per clock mode using DIE[23:0]. A high level (3.3V) indicates two pixels (up to 48-bits) per clock mode using DIE[23:0] for the first pixel and DIO[23:0] for the second pixel.
RESERVED	27	In	This input must be tied high (3.3V), but we recommend that this pin have an option to tie it low.

# **Power Management Pin Description**

Pin Name	Pin #	Туре	Description
PD	26	In	Power Down (active low). A high level (3.3V) indicates normal operation and a low level (GND) indicates power down mode. During power down mode, all data (DIE/DIO[23:0]), data enable (DE), clock (IDCK) and control signals (HSYNC, VSYNC, CTL[3:1]), input buffers are disabled, all output buffers are tri-stated, and all internal circuitry is powered down.

# **Differential Signal Data Pin Description**

Pin Name	Pin #	Туре	Description
TX0+	40	Analog	TMDS Low Voltage Differential Signal output data pairs.
TX0-	39	Analog	
TX1+	43	Analog	
TX1-	42	Analog	
TX2+	46	Analog	
TX2-	45	Analog	
TXC+	35	Analog	TMDS Low Voltage Differential Signal output data pairs.
TXC-	34	Analog	
EXT_SWING	32	Analog	Voltage Swing Adjust. A resistor should tie this pin to AVCC. The amplitude of the voltage swing is
			determined by this resistance. For remote display applications, $400\Omega$ is recommended. For notebook
			computers, $680\Omega$ is recommended.

### **Reserved Pin Description**

Pin Name	Pin #	Туре	Description
RESERVED	20	In	Reserved for future use. Must be tied <b>HIGH</b> for normal operation.
RESERVED	21	In	Reserved for future use. Must be tied <b>LOW</b> for normal operation.
RESERVED	22	In	Reserved for future use. Must be tied <b>HIGH</b> for normal operation.
RESERVED	23	In	Reserved for future use. Must be tied <b>HIGH</b> for normal operation.
RESERVED	28	In	Reserved for future use. Must be tied <b>HIGH</b> for normal operation.
RESERVED	29	In	Reserved for future use. Must be tied <b>HIGH</b> for normal operation.
RESERVED	87	In	Reserved for future use. Must be tied <b>HIGH</b> for normal operation.

## **Power and Ground Pin Description**

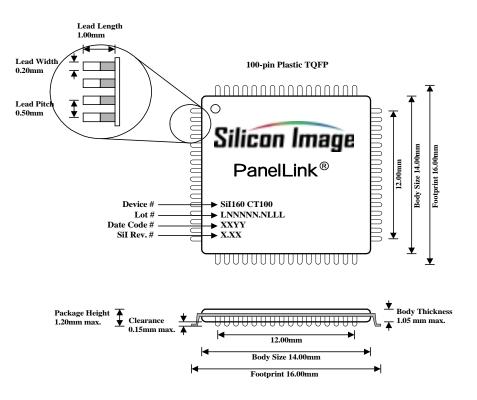
Pin Name	Pin #	Туре	Description
VCC	8,30,56,88	Power	Digital Core VCC, must be set to 3.3V.
GND	7,31,57,67,79,89	Ground	Digital GND.
IVCC	17,66,81,98	Power	Input VCC, must be set to 3.3V.
AVCC	36,38,44	Power	Analog VCC, must be set to 3.3V.
AGND	33,37,41,47	Ground	Analog GND.
PVCC1	18	Power	PLL Analog VCC, must be set to 3.3V.
PVCC2	85	Power	PLL Analog VCC, must be set to 3.3V.
PGND1	19	Ground	PLL Analog GND. PGND1 should not be directly connected to PGND2 before being connected to the GROUND plane. They should be connected individually to the GROUND plane.
PGND2	86	Ground	PLL Analog GND. PGND1 should not be directly connected to PGND2 before being connected to the GROUND plane. They should be connected individually to the GROUND plane.

## **Application Information**

To obtain the most updated Application Notes and other useful information for your design application, please visit the Silicon Image web site at **www.siimage.com**, or contact your local Silicon Image sales office.

## **Package Dimensions**

100-pin TQFP Package Dimensions



## Ordering Information: Part Number: Sil160CT100

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